



ASM International N.V.

## ASM International Hosts SEMICON West Technology Seminar & Webcast

*Seminar topics: atomic layer engineering for manufacturing, second-generation ALD high-k materials and strain engineering, advanced packaging and 3D technologies*

**BILTHOVEN, the Netherlands, June 26, 2007** --- ASM International N.V. (NASDAQ: ASMI and Euronext Amsterdam: ASM) today announced it will host a technology seminar at the SEMICON West trade show in San Francisco, CA on July 18, 2007 from 8:30 to 10:00 a.m. Pacific Daylight Time. The presentations will be held in Room 276, West Mezzanine, Moscone Center and simultaneously webcast on [www.asm.com](http://www.asm.com).

Presenting at the ASMI seminar are Dr. Ivo Raaijmakers, Chief Technology Officer and Director of Research and Development for ASM's front-end semiconductor equipment operations and Charles J. Vath III, Vice President Process & Packaging Technology for ASM Pacific Technology Ltd.

Dr. Raaijmakers' presentation, ***“Breakthrough Technologies – From R&D to Manufacturing”*** will address today's reality of ASM's milestone technologies that incorporate atomic-level engineered interfaces and materials in *manufacturing*, as well as new developments in second-generation high-k atomic layer deposition and strain engineering. Mr. Vath's remarks, ***“Space – The Final Frontier”***, will cover advanced packaging including 3-D technologies.

Those interested in attending the seminar should reply to [maryjo.dieckhaus@asm.com](mailto:maryjo.dieckhaus@asm.com).

SEMICON West attendees are also invited to visit ASM International's booth #618, South Hall and the ASM Pacific Technology booth #7821, Level 1, West Hall.

### **About ASM and ASMPT**

ASM International N.V. and its subsidiaries design and manufacture equipment and materials used to produce semiconductor devices. The company provides production solutions for wafer processing (Front-end segment) as well as assembly and packaging (Back-end segment) through facilities in the United States, Europe, Japan and Asia. ASM International's common stock trades on NASDAQ (symbol ASMI) and the Euronext Amsterdam Stock Exchange (symbol ASM). For more information, visit ASMI's web site at [www.asm.com](http://www.asm.com).

ASM Pacific Technology Ltd. is the world's largest supplier of a full line of assembly and packaging equipment and process solutions for the semiconductor, photonics, and optoelectronics industries. With its financial strength and R&D resources, ASMPT offers its customers total solutions, process innovations, package development and factory automation. With headquarters in Hong Kong, ASMPT has manufacturing operations in China, Singapore and Malaysia. ASMPT is 53%-owned by ASM International N.V. ASM Pacific Technology Ltd. common shares trade on the Hong Kong Exchanges under the symbol: 0522. For more information, visit ASMPT's web site at [www.asmpacific.com](http://www.asmpacific.com).

*Safe Harbor Statement under the U.S. Private Securities Litigation Reform Act of 1995: All matters discussed in this statement, except for any historical data, are forward-looking statements. Forward-looking statements involve risks and uncertainties that could cause actual results to differ materially from those in the forward-looking statements. These include, but are not limited to, economic conditions and trends in the semiconductor industry generally and the timing of the industry cycles specifically, currency fluctuations, the timing of significant orders, market acceptance of new products, competitive factors, litigation involving intellectual property, shareholder and other issues, commercial and economic disruption due to natural disasters, terrorist activity, armed conflict or political instability, epidemics and other risks indicated in the Company's filings from time to time with the U.S. Securities and Exchange Commission, including, but not limited to, the Company's reports on Form 20-F and Form 6-K. The Company assumes no obligation nor intends to update or revise any forward-looking statements to reflect future developments or circumstances.*

